

MA3J142D (MA142WA), MA3J142E (MA142WK)

Silicon epitaxial planar type

For switching circuits

■ Features

- Two isolated elements contained in one package, allowing high-density mounting

■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

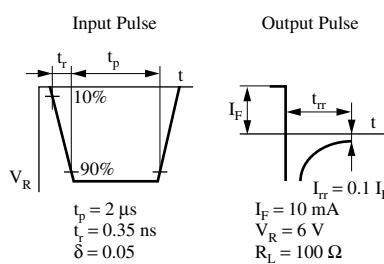
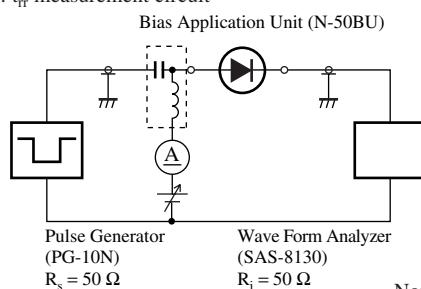
Parameter	Symbol	Rating	Unit
Reverse voltage	V_R	80	V
Maximum peak reverse voltage	V_{RM}	80	V
Forward current	Single I_F	100	mA
	Double	150	
Peak forward current	Single I_{FM}	225	mA
	Double	340	
Non-repetitive peak forward surge current *	Single I_{FSM}	500	mA
	Double	750	
Junction temperature	T_j	150	$^\circ\text{C}$
Storage temperature	T_{stg}	-55 to +150	$^\circ\text{C}$

Note) *: $t = 1 \text{ s}$ **■ Electrical Characteristics $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$**

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Forward voltage	V_F	$I_F = 100 \text{ mA}$			1.2	V
Reverse voltage	V_R	$I_R = 100 \mu\text{A}$	80			V
Reverse current	I_R	$V_R = 75 \text{ V}$			100	nA
Terminal capacitance	MA3J142D C_t	$V_R = 0 \text{ V}$, $f = 1 \text{ MHz}$			15	pF
	MA3J142E				2	
Reverse recovery time *	MA3J142D t_{rr}	$I_F = 10 \text{ mA}$, $V_R = 6 \text{ V}$			10	ns
	MA3J142E	$I_{rr} = 0.1 I_R$, $R_L = 100 \Omega$			3	

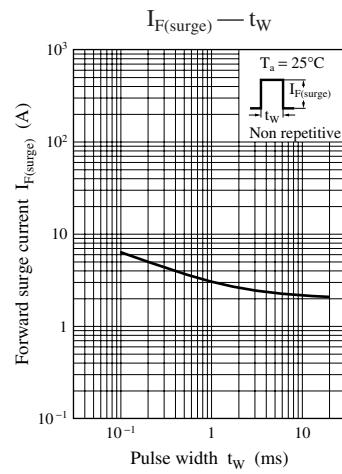
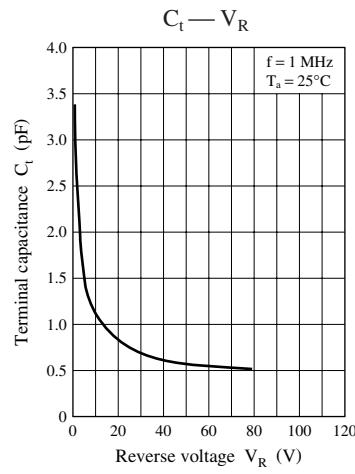
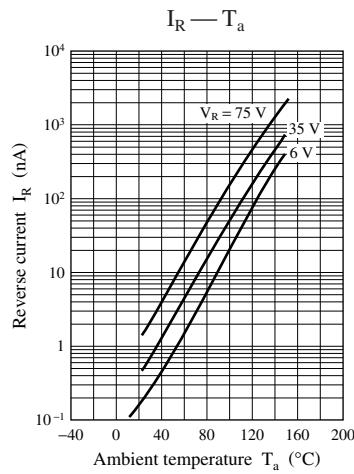
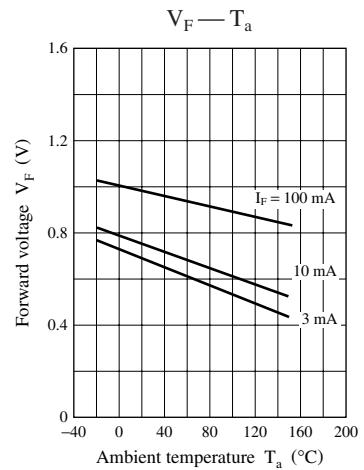
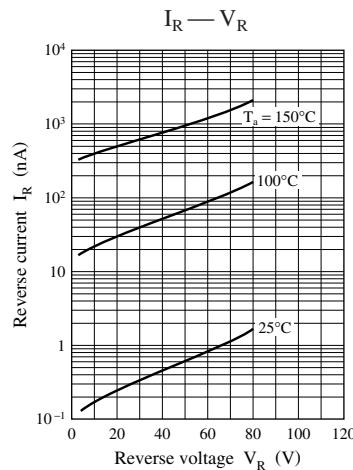
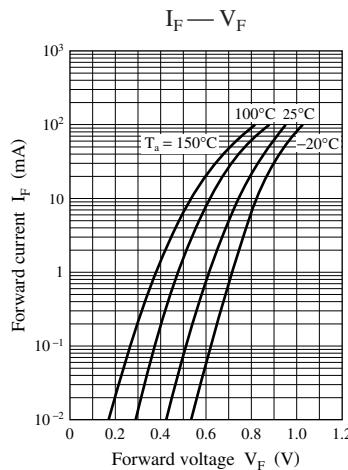
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

2. Absolute frequency of input and output is 100 MHz.

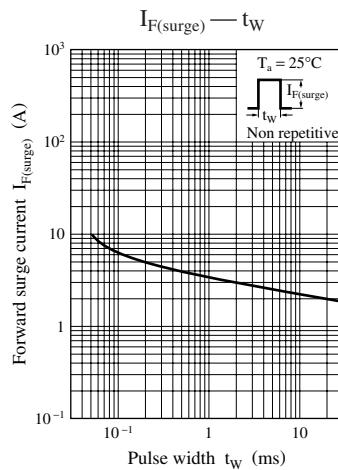
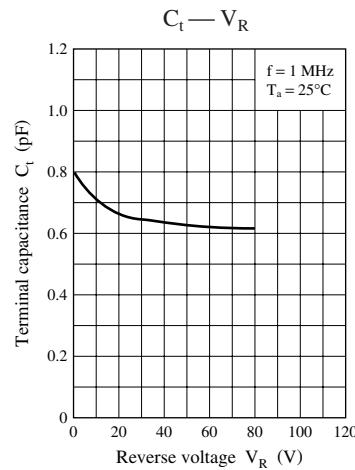
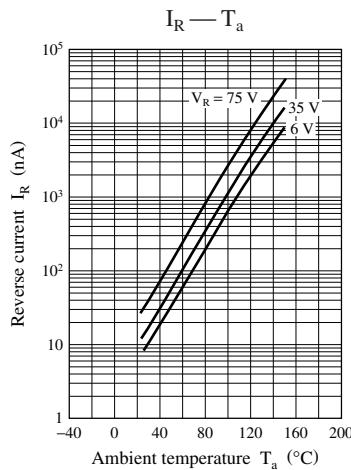
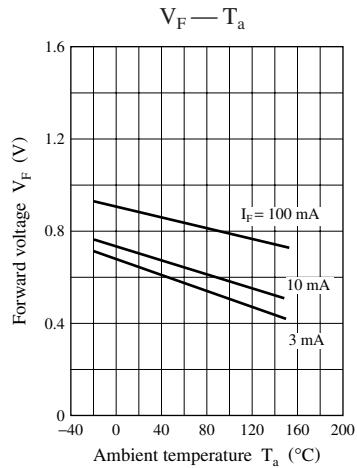
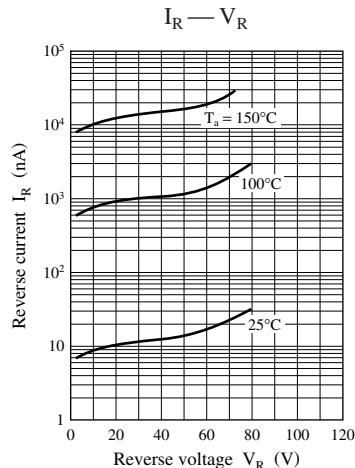
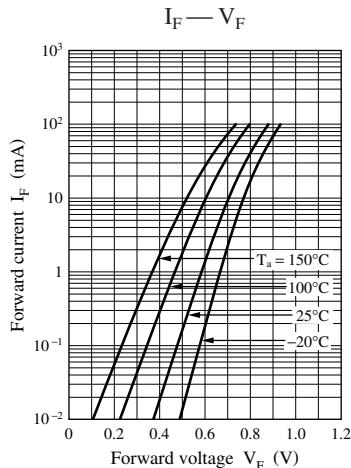
3. *: t_{rr} measurement circuit

Note) The part numbers in the parenthesis show conventional part number.

Characteristics charts of MA3J142D



Characteristics charts of MA3J142E



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